

October 2014

FDMS86252 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

FDMS86252

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 150 V, 16 A, 51 m $\Omega$

## Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 51 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$
- Max  $r_{DS(on)} = 70 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 3.9 \text{ A}$
- Advanced package and silicon combination for low r<sub>DS(on)</sub> and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

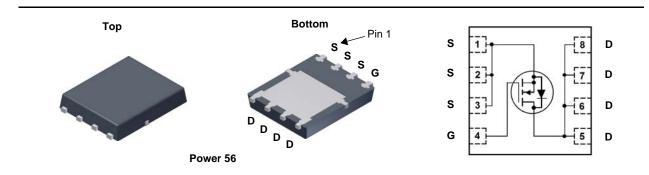


# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

# Application

DC-DC Conversion



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			150	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous T <sub>C</sub> = 25 °C			16	
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	4.6	А
	-Pulsed			20	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	50	mJ
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		69	14/
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

## **Thermal Characteristics**

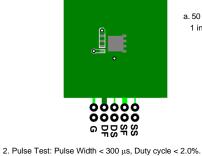
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

## Package Marking and Ordering Information

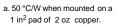
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86252	FDMS86252	Power 56	13 "	12 mm	3000 units

FDMS86252 N-C
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Shielded
N-Channel Shielded Gate PowerTrench <sup>®</sup> I
rTrench <sup>®</sup>
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	cteristics			+		
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.8	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C	2.0	-9	-1.0	mV/°C
j		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.6 A		43.9	51	
	Statia Ducin to Course On Desistance	$V_{GS} = 6 V, I_D = 3.9 A$		50.5	70	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.6 \text{ A},$ T <sub>J</sub> = 125 °C		83	96	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 4.6 \text{ A}$		15		S
_	Output Capacitance Reverse Transfer Capacitance Gate Resistance	f = 1 MHz	0.1	74 4.3 0.4	115 10 1.8	pF pF Ω
C <sub>rss</sub>	Reverse Transfer Capacitance			-		
R <sub>g</sub>			0.1	0.1	1.0	
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			7.7	16	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 4.6 A,		2.3	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		15	27	ns
t <sub>f</sub>	Fall Time			3.2	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		11	15	nC
Q <sub>q</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$ ,		6.1	8.6	nC
9	Gate to Source Charge	I <sub>D</sub> = 4.6 A		2.8		nC
Q <sub>gs</sub>	Gate to Drain "Miller" Charge			2.4		nC
Q <sub>gs</sub>						
Q <sub>gs</sub> Q <sub>gd</sub>	arce Diode Characteristics			0.75	1.2	V
Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	urce Diode Characteristics	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.00	1.3	V
Q <sub>gs</sub> Q <sub>gd</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \ V, \ I_S = 2 \ A \qquad (Note \ 2)$ $V_{GS} = 0 \ V, \ I_S = 4.6 \ A \qquad (Note \ 2)$		0.80	1.5	
Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou				0.80 56	90	ns

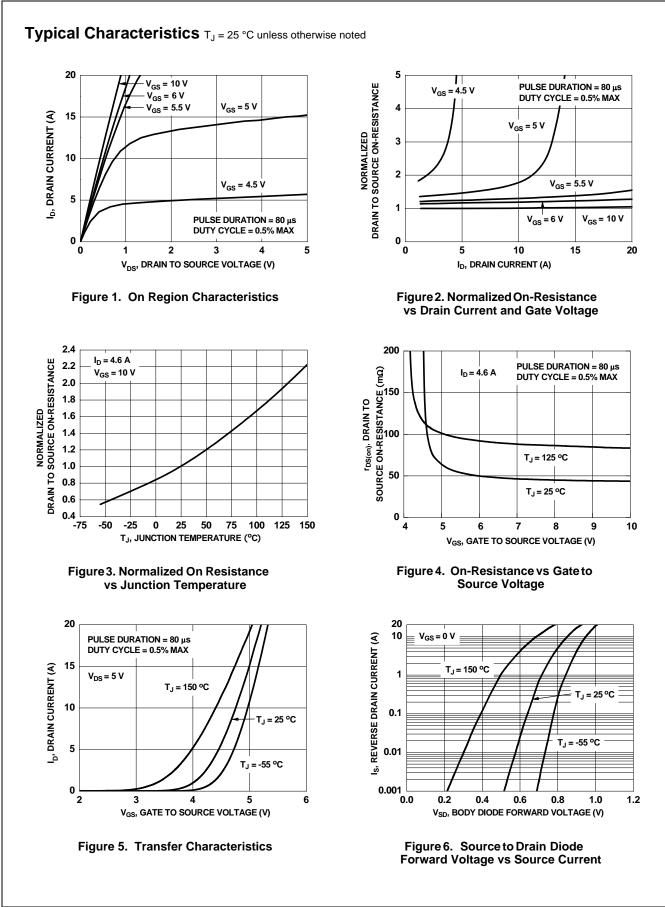


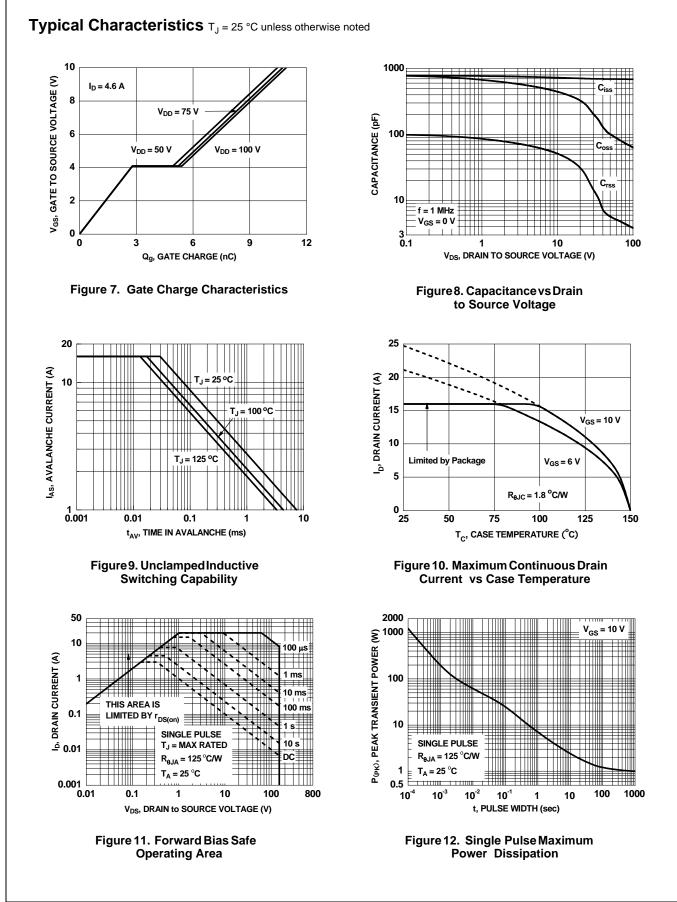
3. Starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 10 A,  $V_{DD}$  = 135 V,  $V_{GS}$  = 10 V.

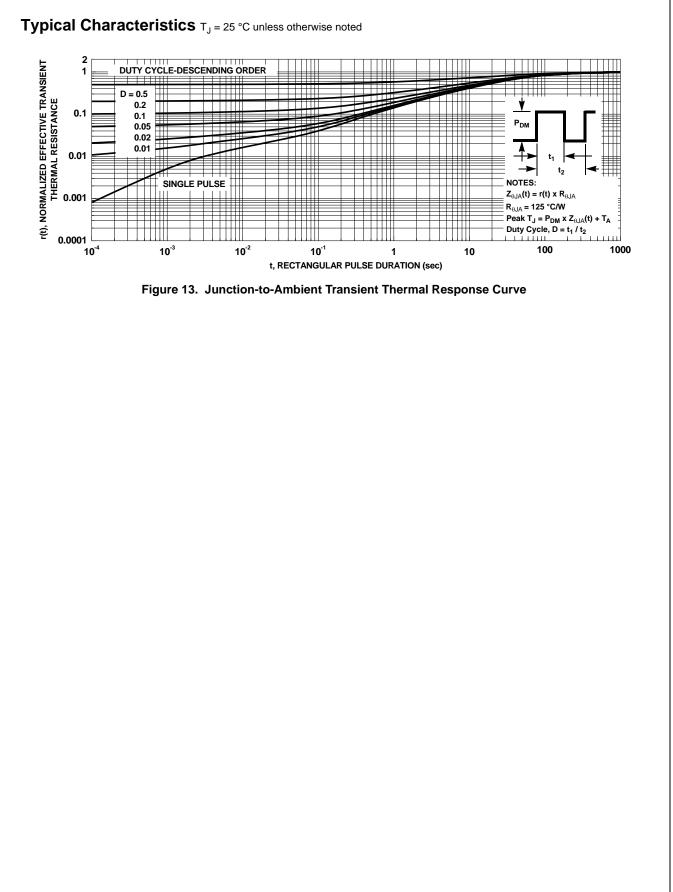


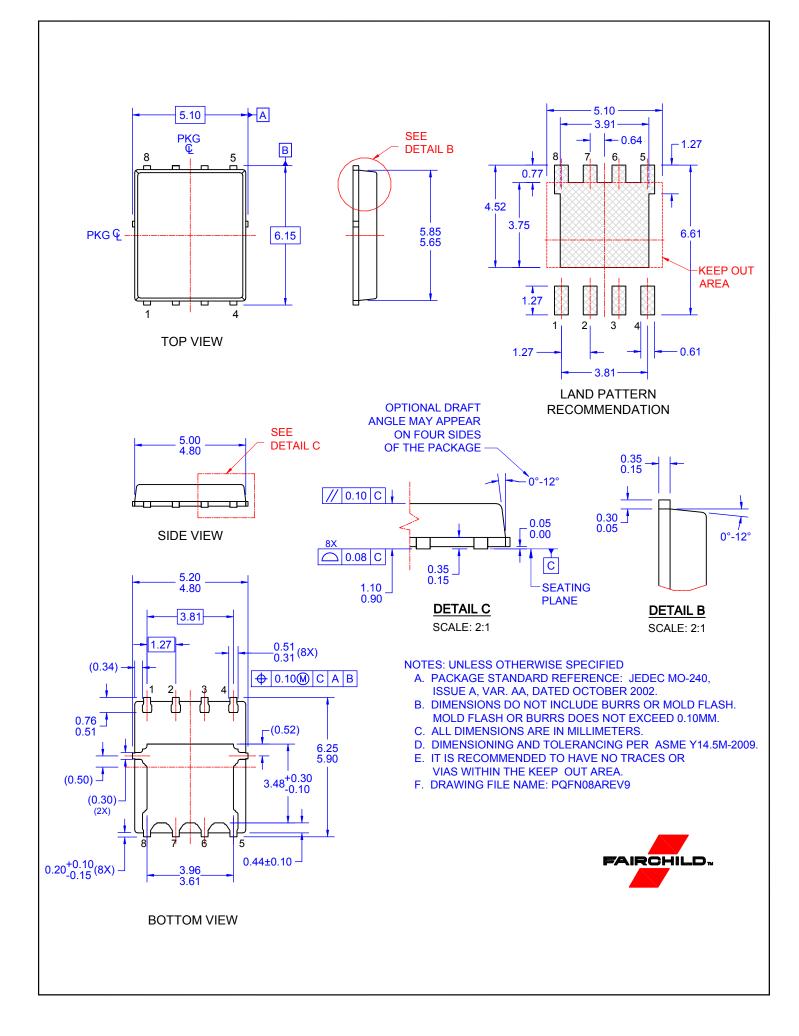


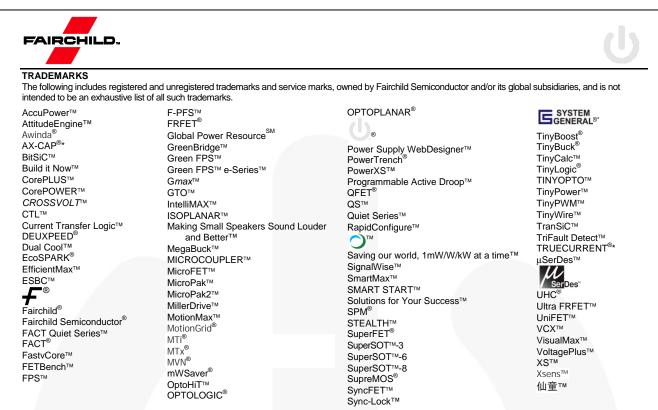
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.











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